

AMP Signal Double Lock

TE Internal #: 1376478-2 PCB Mount Header, Vertical, Wire-to-Board, 2 Position, 2.5 mm [. 098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, AMP Signal Double Lock

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Connector System: Wire-to-Board

Number of Positions: 2

Number of Rows: 1

Centerline (Pitch): 2.5 mm [.098 in]

PCB Mount Orientation: Vertical

Features

connectivity

Product Type Features

Connector System	Wire-to-Board	
Header Type	Fully Shrouded	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
PCB Connector Assembly Type	PCB Mount Header	
Configuration Features		
Number of Positions	2	
Number of Rows	1	
PCB Mount Orientation	Vertical	
Electrical Characteristics		
Operating Voltage	50 VAC	
Body Features		
Primary Product Color	Natural	

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Contact Features

Contact Mating Area Length	4.35 mm[.17 in]	
Mating Square Post Dimension	.5 mm[.02 in]	
PCB Contact Termination Area Plating Material Thickness	.8 – 1.6 μm[31.49 – 62.99 μin]	
Contact Layout	Inline	
Contact Underplating Material Thickness	.5 – 1.2 μm[19.68 – 47.24 μin]	
Contact Mating Area Plating Material Thickness	.8 μm[31.49 μin]	
PCB Contact Termination Area Plating Material Finish	Matte	
Contact Shape & Form	Square	
Contact Mating Area Plating Material Finish	Matte	
Contact Underplating Material	Copper	
PCB Contact Termination Area Plating Material	Tin	
Contact Base Material	Brass	
Contact Mating Area Plating Material	Tin	
Contact Type	Pin	
Contact Current Rating (Max)	2.5 A	

Termination Features

Square Termination Post & Tail Dimension	.5 mm[.02 in]	
Termination Post & Tail Length	3.2 mm[.126 in]	
Termination Method to Printed Circuit Board	Through Hole - Solder	
Mechanical Attachment		
PCB Mount Alignment Type	Boss	
Mating Alignment Type	Polarization	
Mating Retention	With	
PCB Mount Retention Type	Kinked	
Mating Retention Type	Latch	
Connector Mounting Type	Board Mount	
Mating Alignment	With	
PCB Mount Alignment	With	
PCB Mount Retention	With	
Housing Features		
Housing Features		
Housing Features Housing Material	Nylon 66 GF	

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Dimensions

Connector Length	7.5 mm[.29 in]	
Connector Height	8.8 mm[.34 in]	
Connector Width	8.2 mm[.32 in]	
PCB Thickness (Recommended)	1.6 mm[.063 in]	
Usage Conditions		
Operating Temperature Range	-30 – 105 °C[-22 – 221 °F]	
Operation/Application		
Circuit Application	Signal	
Packaging Features		
Packaging Quantity	400	
Packaging Type	Bag, Box	
Product Compliance		
For compliance documentation, visit the product page on TE.com>		
EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Not Yet Reviewed	

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUL 2021 (219) Does not contain REACH SVHC	
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.	
Solder Process Capability	Wave solder capable to 265°C	

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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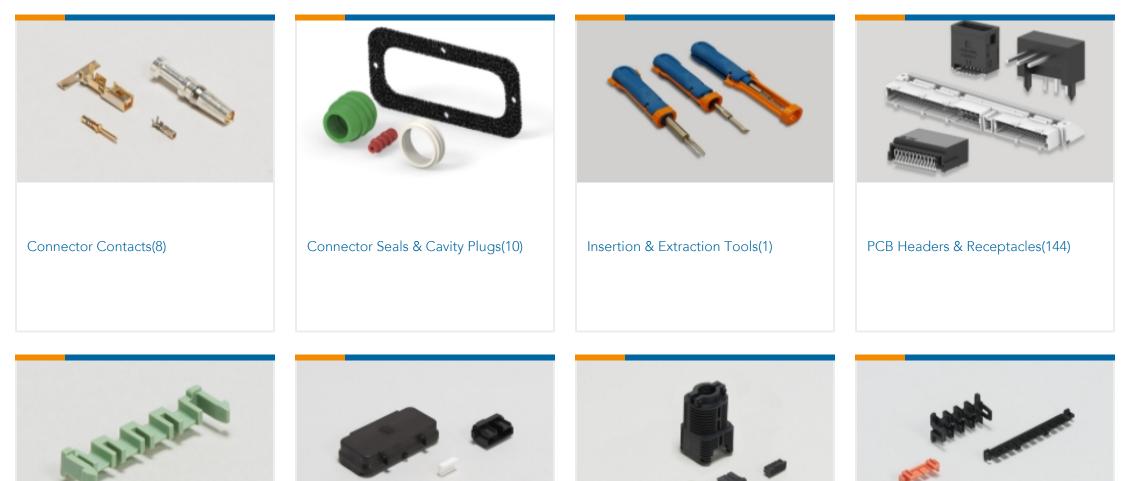


Compatible Parts





Also in the Series AMP Signal Double Lock



Ser.		s * *	Acres .
PCB Latches, Locks & Retainers(17)	Rectangular Caps & Covers(1)	Rectangular Connector Housings(23)	Rectangular Connector Locking(2)
			the the solution
Rectangular Power Connectors(3)	Standard Rectangular Connectors(1)	Wire-to-Board Connector Assemblies & Housings(76)	Wire-to-Board Connector Contacts(6)

Customers Also Bought

PCB Mount Header, Vertical, Wire-to-Board, 2 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, AMP Signal Double Lock





Documents

Product Drawings 2.5 SMC HDR 2POS WHITE (LP)

English

CAD Files 3D PDF

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English

Customer View Model ENG_CVM_1376478-2_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_1376478-2_E.3d_igs.zip

English

Customer View Model

ENG_CVM_1376478-2_E.3d_stp.zip

English

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Product Specifications Application Specification

English

Product Environmental Compliance TE Material Declaration

English